

US00D810688S

(12) **United States Design Patent** (10) **Patent No.:** **US D810,688 S**
Zhu (45) **Date of Patent:** **** Feb. 20, 2018**

(54) **CONDUCTIVE PLATE** 7,830,648 B2 * 11/2010 Strong H02B 1/20
174/40 R
(71) Applicant: **SHANUTEC (SHANGHAI) CO., LTD.**, Shanghai (CN) D743,910 S * 11/2015 Murphy D13/147
D779,436 S * 2/2017 Huynh D13/139.6

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(**) Term: **15 Years**

(21) Appl. No.: **29/572,434**

(22) Filed: **Jul. 28, 2016**

(51) **LOC (11) Cl.** **13-03**

(52) **U.S. Cl.**
USPC **D13/146**

(58) **Field of Classification Search**
USPC D13/128, 129, 130, 131, 132, 133, 146,
D13/147, 154, 182, 184, 199
CPC H01R 24/00; H01R 24/78; H01R 25/14;
H01R 25/142; H01R 25/16; H01R 25/162
See application file for complete search history.

(56) **References Cited**

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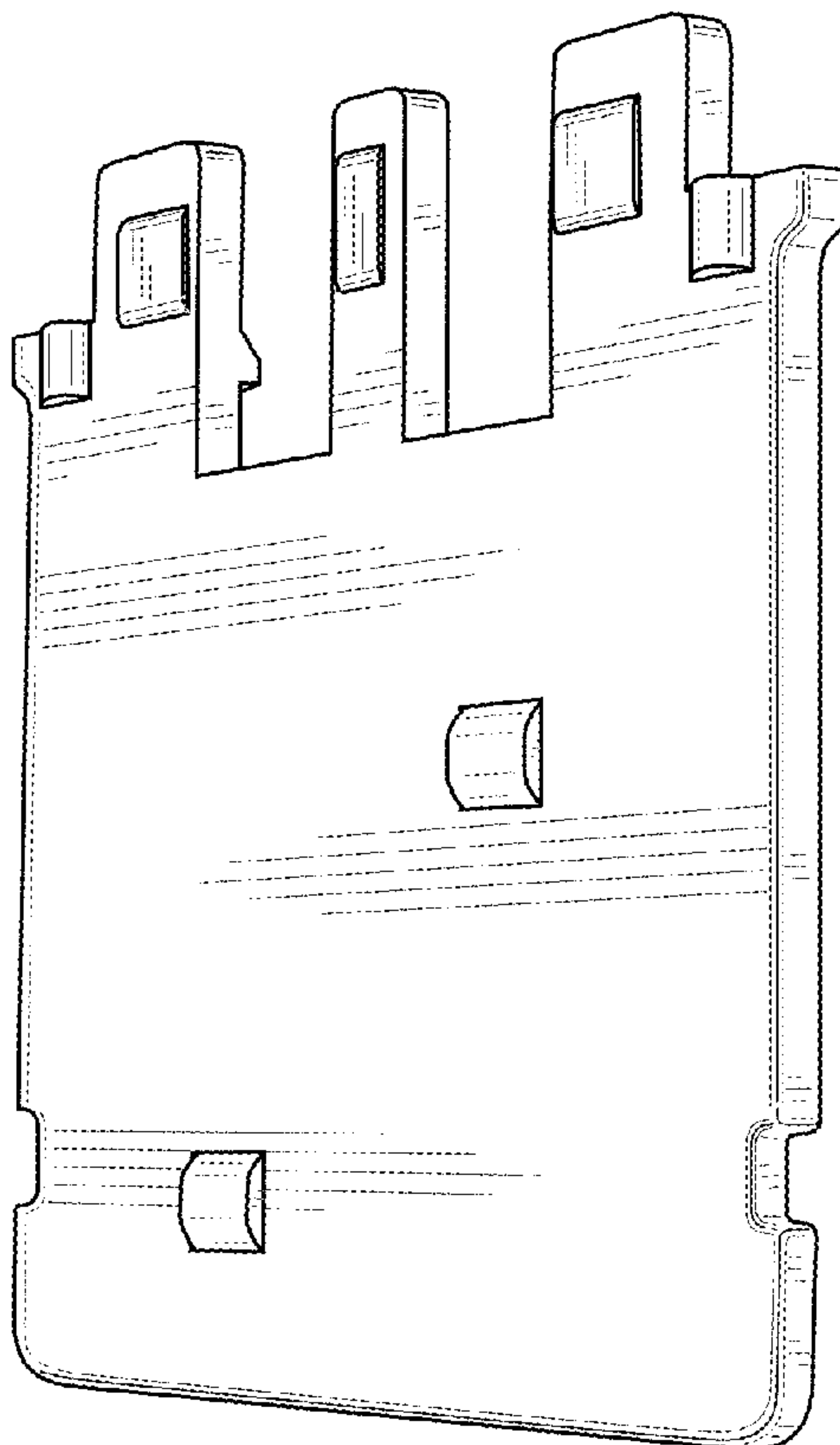
(57) **CLAIM**

The ornamental design for a conductive plate, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a conductive plate showing my new design;
FIG. 2 is a front view thereof;
FIG. 3 is a rear view thereof;
FIG. 4 is a right view thereof;
FIG. 5 is a left view thereof;
FIG. 6 is a top view thereof; and,
FIG. 7 is a bottom view thereof.

1 Claim, 7 Drawing Sheets



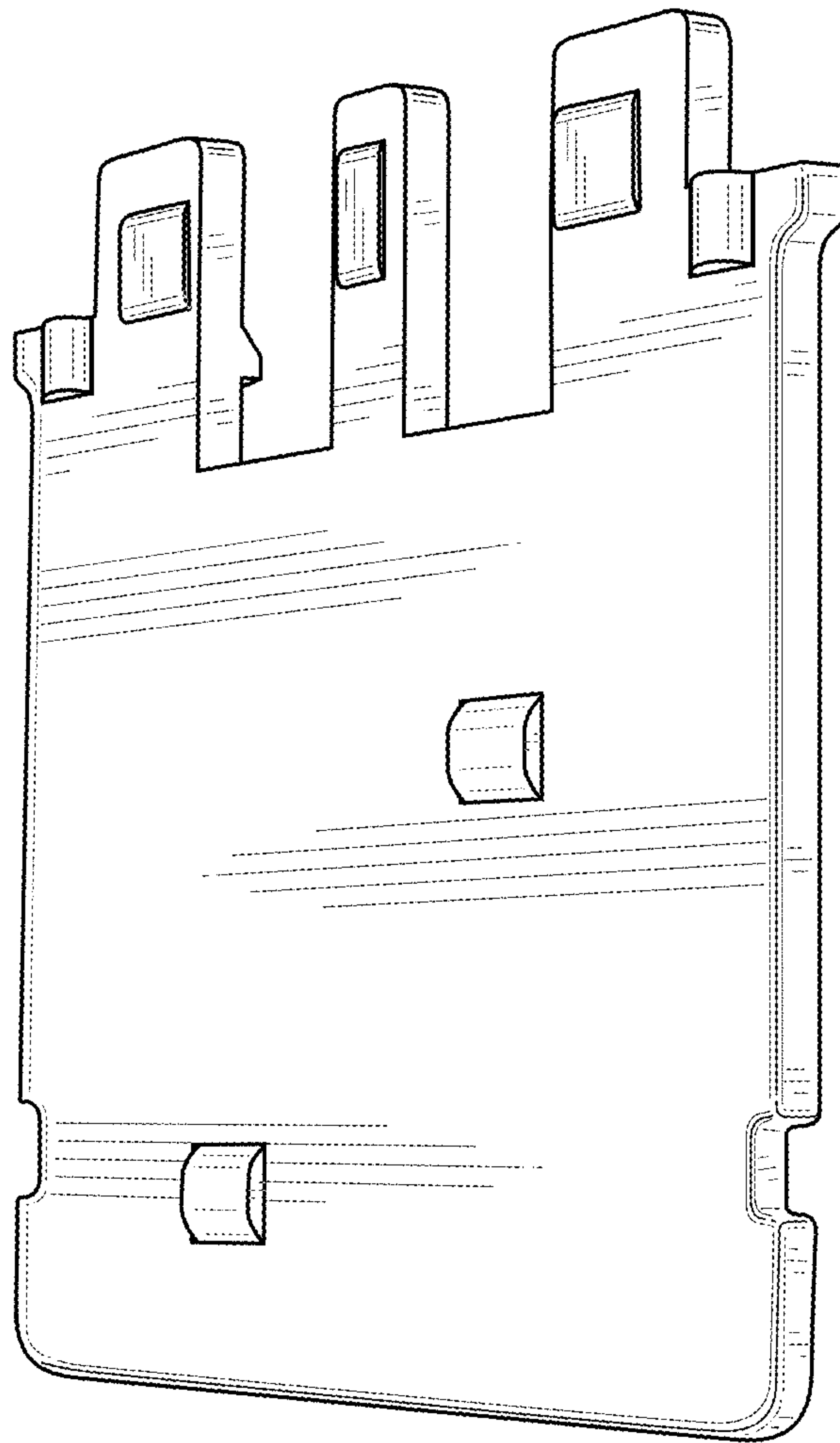


FIG. 1

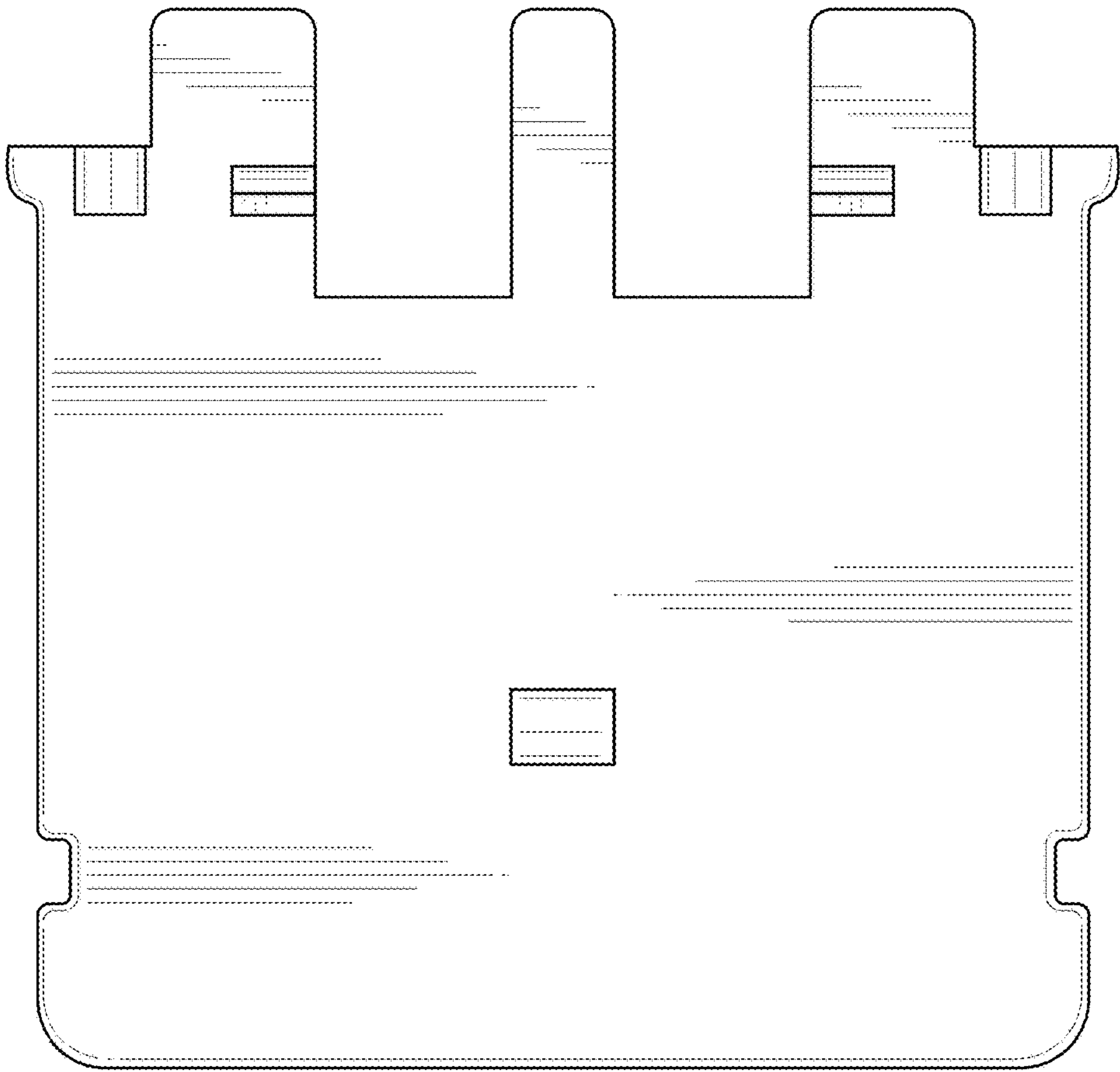


FIG. 2

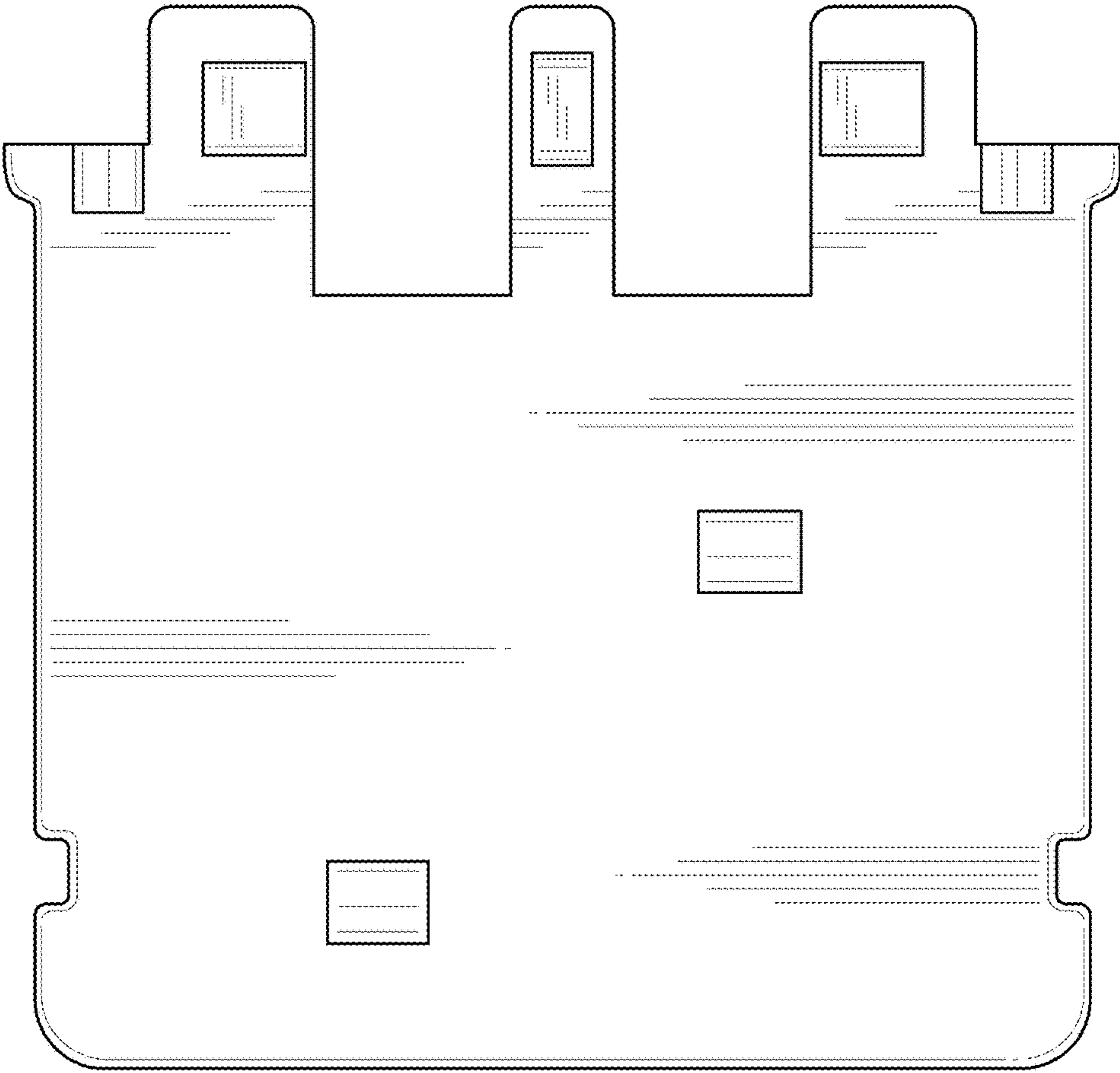


FIG. 3

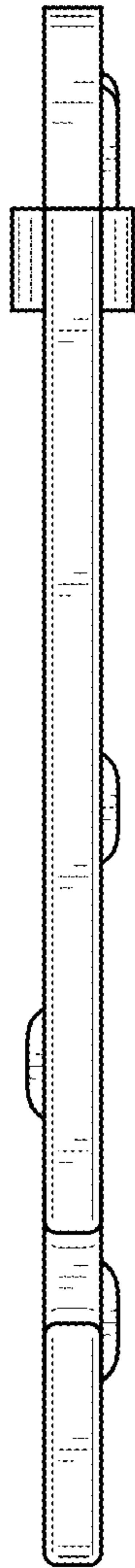


FIG. 4

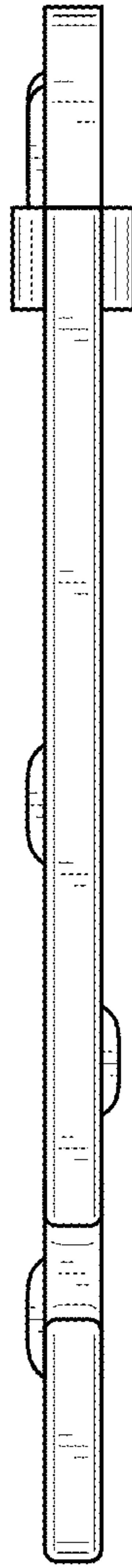


FIG. 5

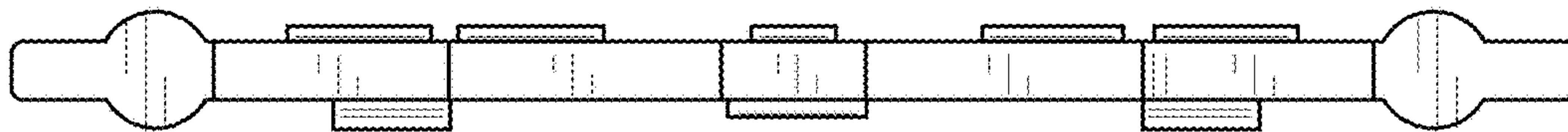


FIG. 6

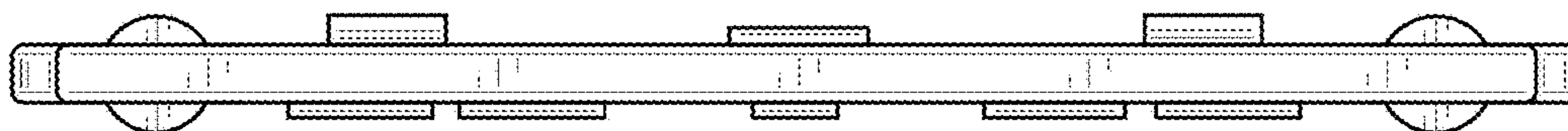


FIG. 7